

650V N-Channel Super Junction MOSFET

Voltage	650 V	R _{dson}	60mΩ
Current	58.3 A	Q _g	100.3nC

Feature:

- R_{DSON} Max, V_{GS}@10V : 60mΩ
- Body diode with fast recovery characteristics
- High Speed Switching and Low R_{DSON}
- 100% Avalanche Tested
- 100% R_G Tested
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

Mechanical Data

- Case: TOLLK package
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 0.775 grams

Application

- Server Power/ Telecom Power / Industrial Power.

Absolute Maximum Ratings (T_A = 25 °C unless otherwise specified)

PARAMETER	SYMBOL	LIMIT	UNITS
Drain-Source Voltage @ T _{jmax}	V _{DS}	700	V
Drain-Source Voltage	V _{DS}	650	
Gate-Source Voltage	V _{GS}	±30	
Continuous Drain Current	I _D	58.3	A
T _C =100°C	I _D	36.9	
Pulsed Drain Current	I _{DM}	128	A
Single Pulse Avalanche Energy ^(Note 6)	E _{AS}	480	mJ
MOSFET dv/dt ruggedness	dv/dt	120	V/ns
Diode dv/dt	dv/dt	70	V/ns
Power Dissipation	P _d	500	W
T _C =100°C	P _d	200	
Operating Junction and Storage Temperature Range	T _J , T _{STG}	-55~150	°C

Thermal Characteristics

PARAMETER	SYMBOL	VALUES			UNITS
		MIN.	TYP.	MAX.	
Thermal Resistance	R _{θJC}	-	0.18	0.25	°C/W
	R _{θJA}	-	30	50	°C/W

Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Static						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	650	-	-	V
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	3.3	4.0	4.7	
Drain-Source On-State Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=23\text{A}$ (Note 1)	-	47.4	60	$\text{m}\Omega$
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}}=650\text{V}, V_{\text{GS}}=0\text{V}$	-	-	10	μA
Gate-Source Leakage Current	I_{GSS}	$V_{\text{GS}}=\pm 30\text{V}, V_{\text{DS}}=0\text{V}$	-	-	± 100	nA
Transfer characteristics	g_{fs}	$V_{\text{DS}}=20\text{V}, I_{\text{D}}=46\text{A}$	-	50.6	-	S
Dynamic (Note 5)						
Total Gate Charge	Q_g	$V_{\text{DS}}=400\text{V}, I_{\text{D}}=46\text{A}, V_{\text{GS}}=10\text{V}$	-	100.3	-	nC
Gate-Source Charge	Q_{gs}		-	29.3	-	
Gate-Drain Charge	Q_{gd}		-	41.6	-	
Input Capacitance	C_{iss}	$V_{\text{DS}}=400\text{V}, V_{\text{GS}}=0\text{V}, f=250\text{kHz}$	-	4614	-	pF
Output Capacitance	C_{oss}		-	63.5	-	
Reverse Transfer Capacitance	C_{rss}		-	7	-	
Effective Output Capacitance Energy Related	$C_{\text{o(er)}}$	$V_{\text{DS}}=0\text{V}$ to 400V , $V_{\text{GS}}=0\text{V}, f=250\text{kHz}$ (Note 4)	-	123.1	-	
Turn-On Delay Time	$t_{\text{d(on)}}$	$V_{\text{DD}}=400\text{V}, I_{\text{D}}=46\text{A}, V_{\text{GS}}=10\text{V}, R_{\text{G}}=10\Omega$ (Note 2)	-	55.3	-	ns
Turn-On Rise Time	t_r		-	181.3	-	
Turn-Off Delay Time	$t_{\text{d(off)}}$		-	113	-	
Turn-Off Fall Time	t_f		-	114	-	
Gate Resistance	R_g	$f=1.0\text{MHz}$	-	6	12	Ω
Drain-Source Diode						
Maximum Continuous Drain-Source Diode Forward Current	I_s		-	-	58.3	A
Diode Forward Voltage	V_{SD}	$I_s=23\text{A}, V_{\text{GS}}=0\text{V}$	-	0.90	1.5	V
Reverse Recovery Charge	Q_{rr}	$I_s=46\text{A}$ $dI/dt=100\text{A}/\mu\text{s}$	-	2.3	-	μC
Reverse Recovery Time	T_{rr}		-	154.3	-	ns
Reverse Recovery Current	I_{rrm}		-	12	-	A

NOTES :

1. Pulse width $\leq 380\text{us}$, Duty cycle $\leq 2\%$.
2. Essentially independent of operating temperature typical characteristics.
3. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance.
4. $C_{\text{o(er)}}$ is a capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0V to 400V .
5. Guaranteed by design, not subject to production testing.
6. E_{AS} is calculated based on the condition of $L = 10 \text{ mH}$, $I_{\text{AS}} = 9.8 \text{ A}$, $V_{\text{DD}} = 50 \text{ V}$, $V_{\text{GS}} = 10 \text{ V}$, however, PANJIT test $L=10\text{mH}$, $I_{\text{AS}}=7.8\text{A}$ 100% in mass production.

TYPICAL CHARACTERISTIC CURVES

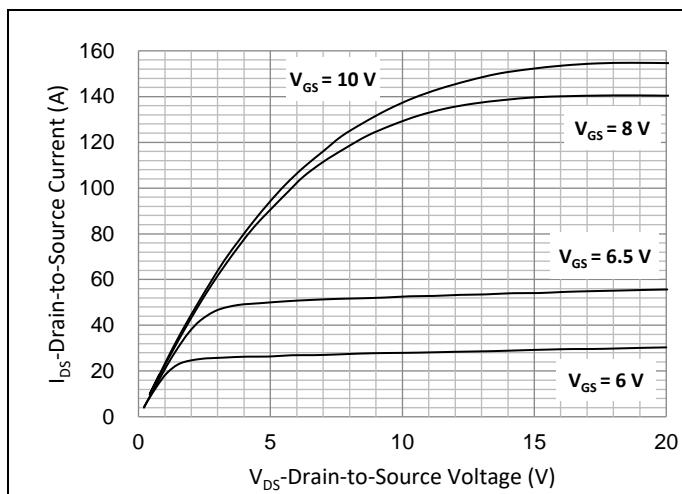


Fig.1 Output Characteristics

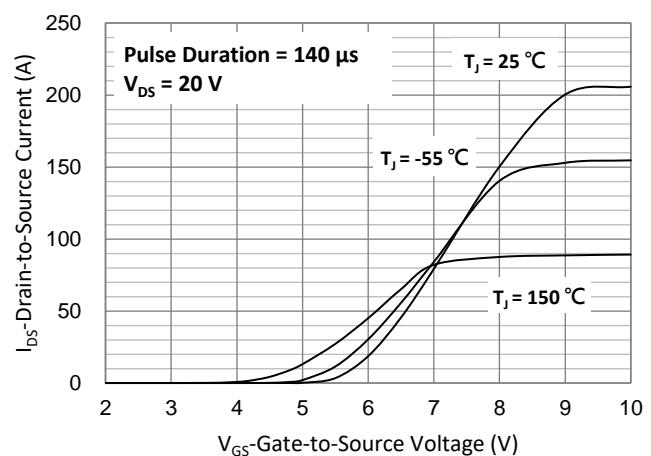


Fig.2 Transfer Characteristics

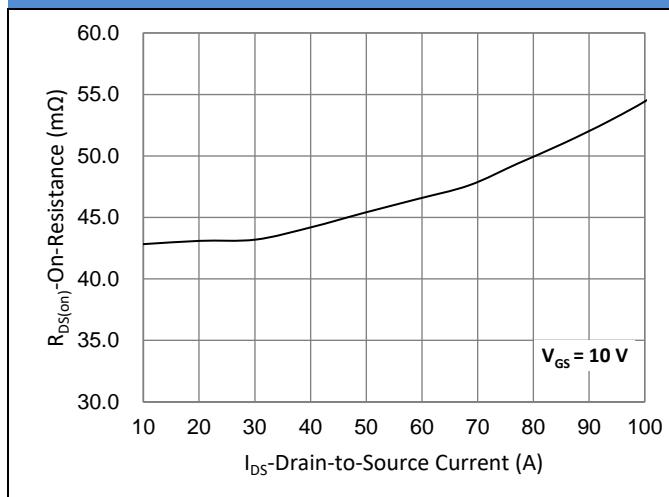


Fig.3 On-Resistance vs. Drain Current

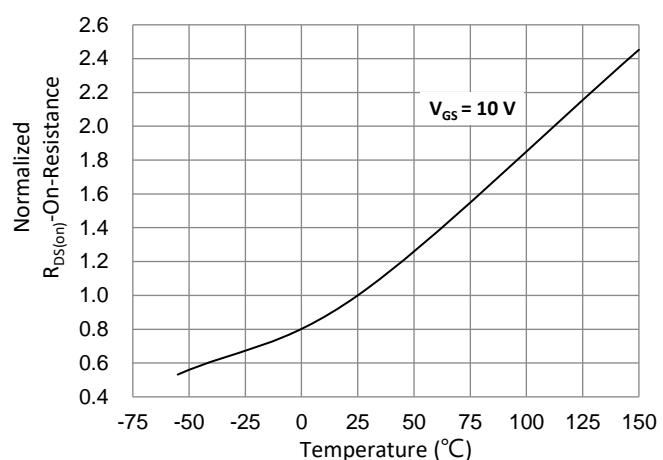


Fig.4 On-Resistance vs. Junction Temperature

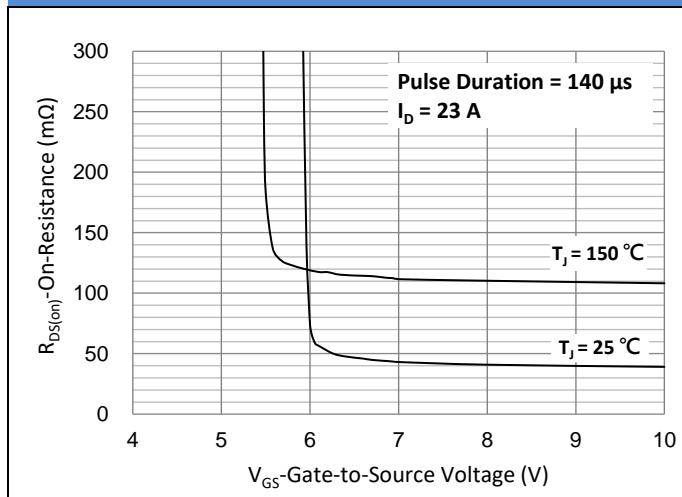


Fig.5 Capacitance vs. Drain-Source Voltage

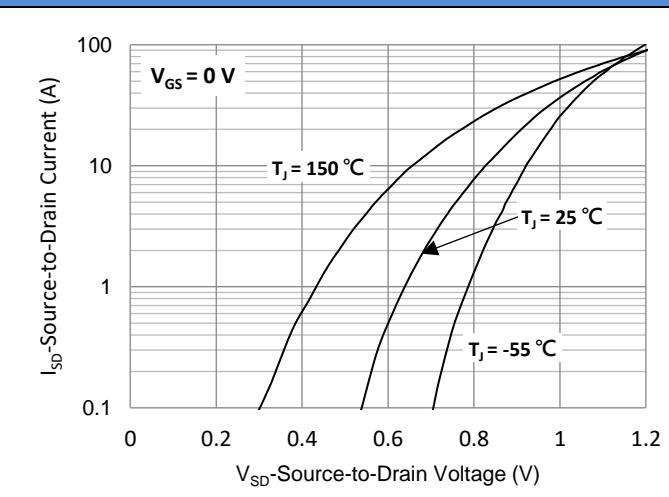


Fig.6 Source-Drain Diode Forward Voltage

TYPICAL CHARACTERISTIC CURVES

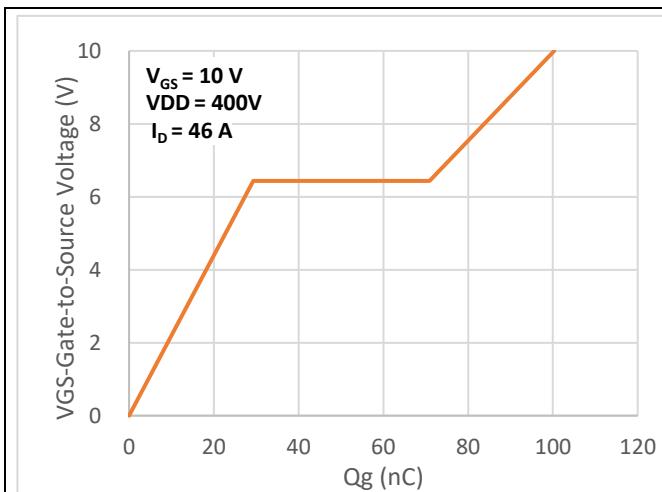


Fig.7 Gate-Charge Characteristics

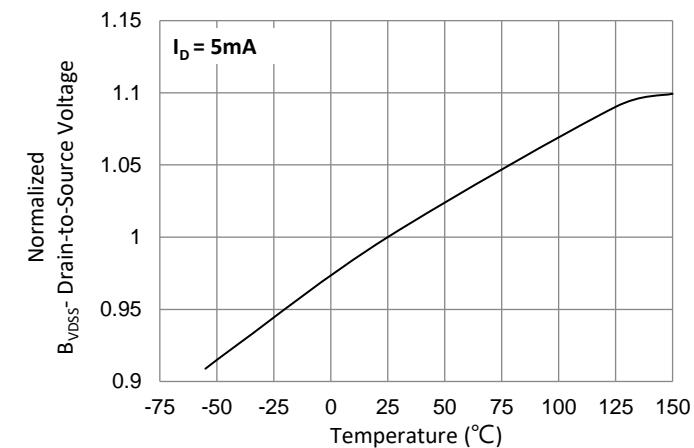


Fig.8 Breakdown Voltage Variation vs. Temperature

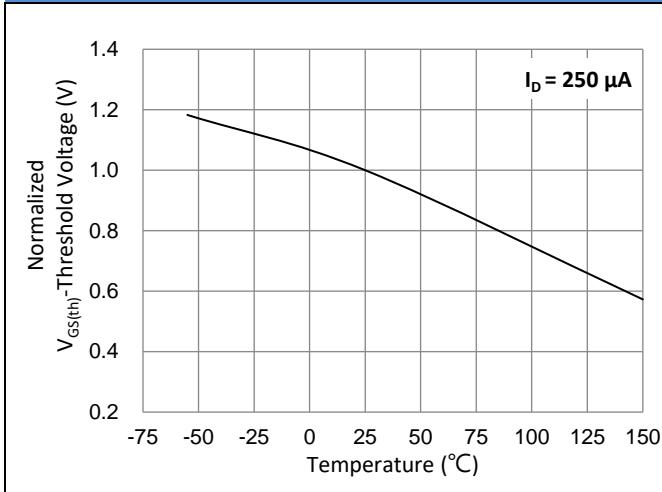


Fig.9 Threshold Voltage Variation with Temperature

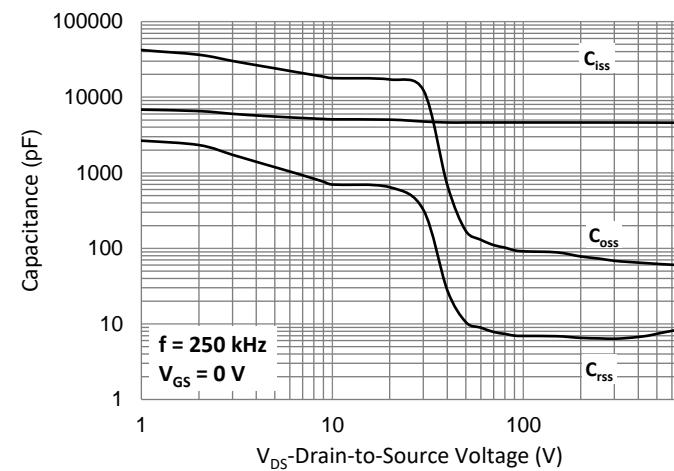


Fig.10 Drain Current vs. Case Temperature

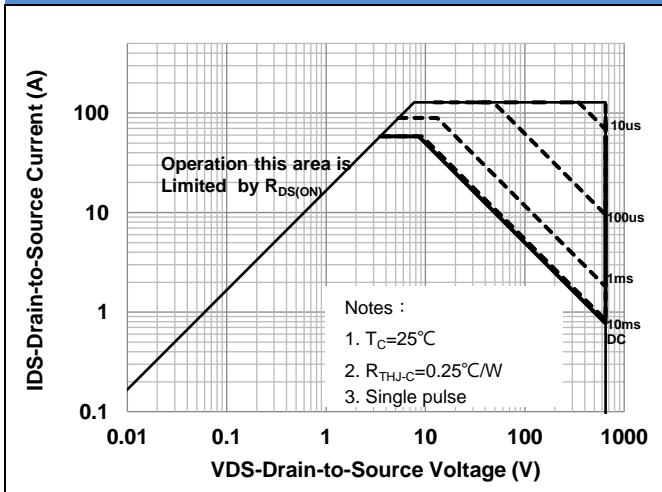


Fig.11 Maximum Safe Operating Area

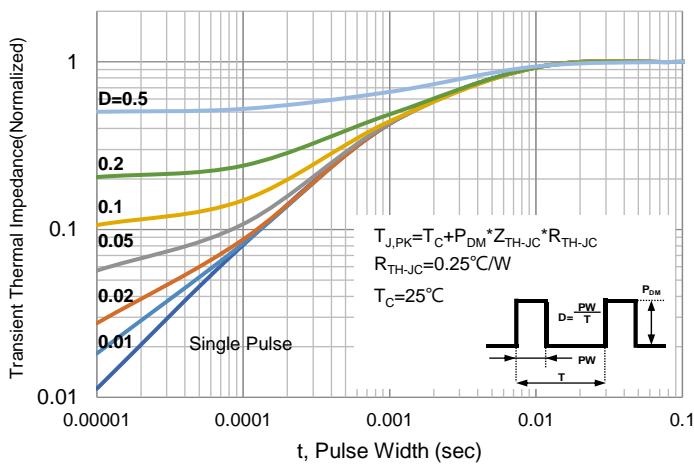


Fig.12 Normalized Transient Thermal Impedance

TYPICAL CHARACTERISTIC CURVES

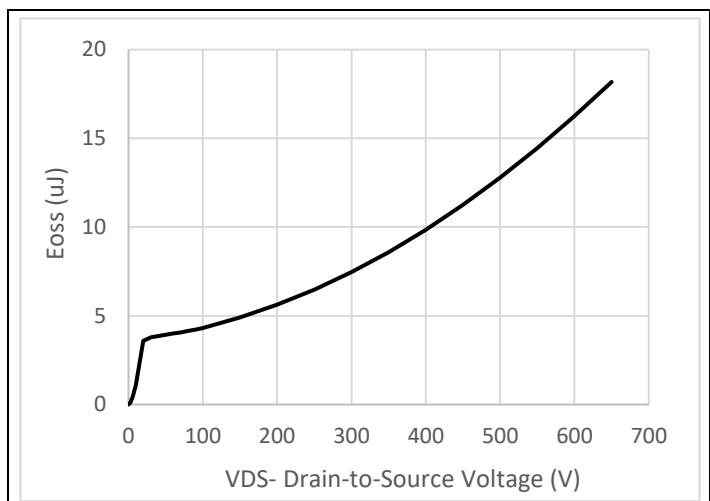
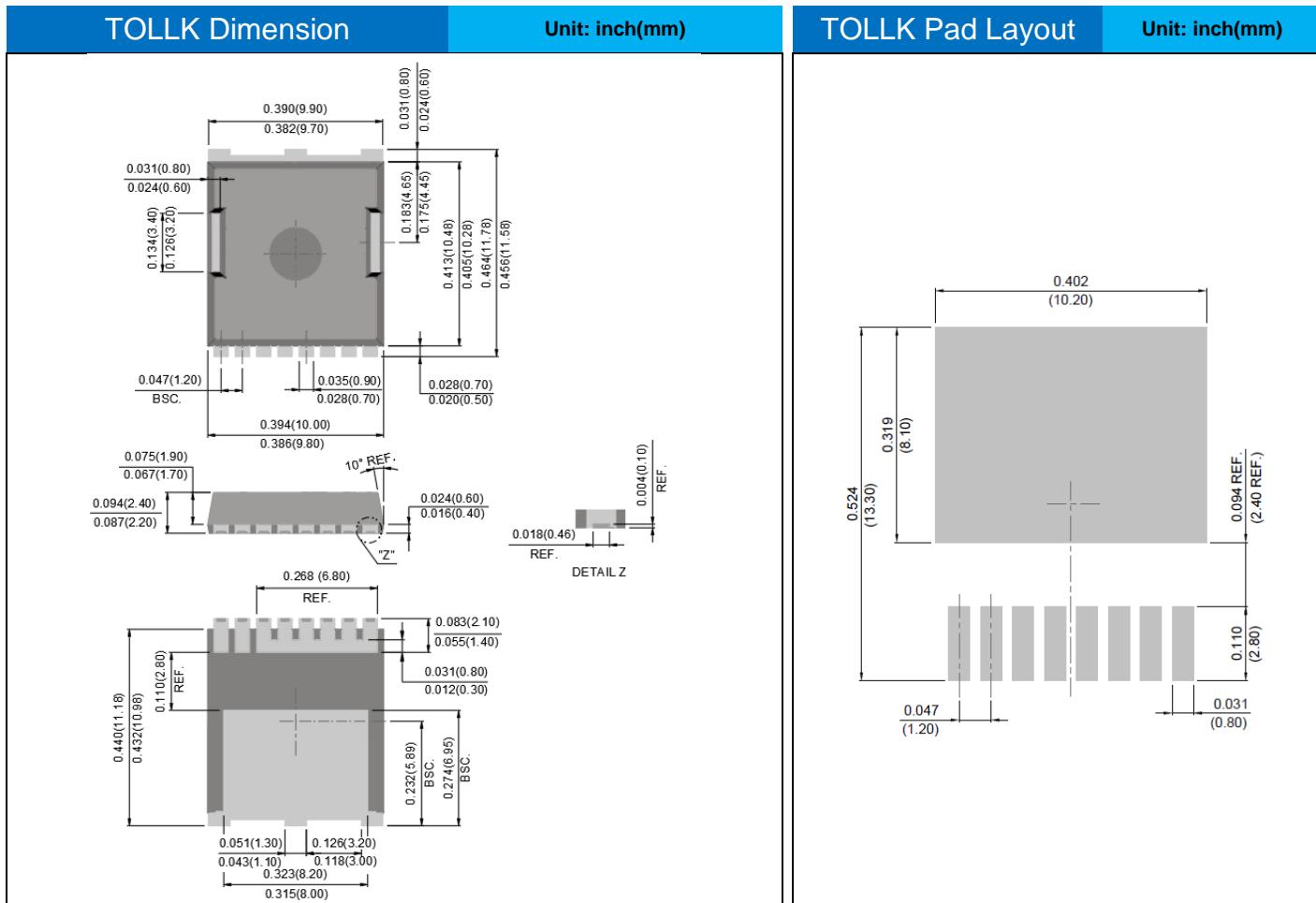


Fig.13 Typ. Coss Stored Energy

Product and Packing Information

Part No.	Package Type	Packing Type	Marking
PJMN060N65FR2	TOLLK	2000 pcs / 13" reel	060N65FR2

Packaging Information



Marking Diagram

PJ
060N65FR2
YWLL x

Y = Year Code
W = Week Code (A~Z)
LL = Lot Code (00~99)
x = Production Line Code

Disclaimer

- Reproducing and modifying information of the document is prohibited without permission from Panjit International Inc..
- Panjit International Inc. reserves the rights to make changes of the content herein the document anytime without notification. Please refer to our website for the latest document.
- Panjit International Inc. disclaims any and all liability arising out of the application or use of any product including damages incidentally and consequentially occurred.
- Panjit International Inc. does not assume any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.
- Applications shown on the herein document are examples of standard use and operation. Customers are responsible in comprehending the suitable use in particular applications. Panjit International Inc. makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.
- The products shown herein are not designed and authorized for equipments requiring high level of reliability or relating to human life and for any applications concerning life-saving or life-sustaining, such as medical instruments, transportation equipment, aerospace machinery et cetera. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Panjit International Inc. for any damages resulting from such improper use or sale.
- Since Panjit uses lot number as the tracking base, please provide the lot number for tracking when complaining.